

32.768KHZ IoT OPTIMIZED SMD CRYSTAL

ABS07W



3.2 x 1.5 x 0.9 mm

Pb RoHS/RoHS II Compliant

MSL = N/A: NOT APPLICABLE

FEATURES

- Exceptionally low plating load of 3.0pF, ideal for wearables, wireless, and IoT applications
- Simultaneously optimized for ESR over extended operating temperature range
- Miniature 3.2x1.5x0.9 mm SMD package, ideally suited for space constrained designs
- Available with ±10 ppm set tolerance
- Seam sealed package for long term reliability

APPLICATIONS

- Wearables
- Wireless Modules
- Internet of Things (IoT)
- Bluetooth/Bluetooth Low Energy (BLE)
- Machine-to-Machine (M2M) Connectivity
- Ultra Low Power MCU
- Near Field Communication (NFC)
- ISM Band Applications
- Ultra low power, energy saving MCU

STANDARD SPECIFICATIONS

PARAMETERS	MINIMUM	TYPICAL	MAXIMUM	UNITS	NOTES
Frequency	32.768			kHz	
Operation Mode	Flexural Mode (Tuning Fork)				
Operating Temperature	-40		+125	°C	See options
Storage Temperature	-55		+125	°C	
Frequency Tolerance @ +25°C	-10		+10	ppm	Refer to Note #1, ±20 ppm is also available
Shift through standard RoHS Reflow, (2) reflow cycles maximum	-2.00		+2.00	ppm	260°C peak maximum reflow temperature, relative to stand-alone set-tolerance frequency
Temperature Coefficient	-0.040	-0.036		ppm/T²	
Turn-over temperature	+20	+25	+30	°C	
Frequency Stability Over Operating Temperature, relative to in-circuit measured frequency post reflow	-200		-100	ppm	Over -40°C to +85°C
	-275		-100	ppm	Over -40°C to +105°C
	-450		-100	ppm	Over -40°C to +125°C
Load capacitance (CL)	3			pF	Refer to Note #2
Equivalent Series Resistance (ESR)		< 40	45	kΩ	@ +25±3°C
		< 45	55	kΩ	Over -40°C to +85°C
		< 50	60	kΩ	Over -40°C to +105°C
		< 60	70	kΩ	Over -40°C to +125°C
Shunt capacitance (C0)		1.15	1.30	pF	Combined Electrode & Package Capacitance
Motional Capacitance (C1)		4.68		fF	C1 also referred as Cm
Motional Inductance (L1)		5,048,571		mH	L1 also referred as Lm
Drive Level		0.1	0.5	μW	
Crystal sensitivity to closed-loop oscillator loading (Ts)	125		140	ppm/pF	Refer to Note #3
Q value	13000				Quality Factor
Aging @ +25°C±3°C [First Year]	-3		+3	ppm	Relative to post reflow measured frequency
Aging @ +25°C±3°C [Over 10-years]	-10		+10	ppm	Relative to post reflow measured frequency
Insulation Resistance	500			MΩ	@ 100Vdc

Note #1: With an effective loop capacitance of 3.0pF, the oscillator circuit will be within set-tolerance specification; less any frequency shift due to the reflow process.

Note #2: The oscillator loop needs to present an effective loop capacitance of 3.0 pF to track the stand-alone crystal frequency. This loop capacitance is essential to ensure highest possible Closed-Loop Safety Factor for the entire population of crystals.

Note #3: $T_s = - (C1) / [2*(C0 + CL)^2]$ Where CL = 3pF

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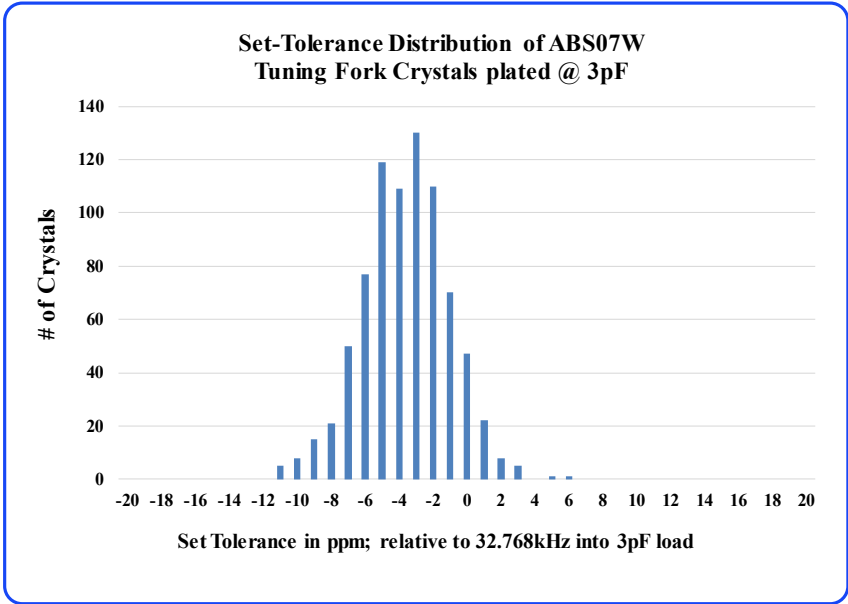
MSL = N/A: NOT APPLICABLE

OPTIONS AND PART IDENTIFICATION

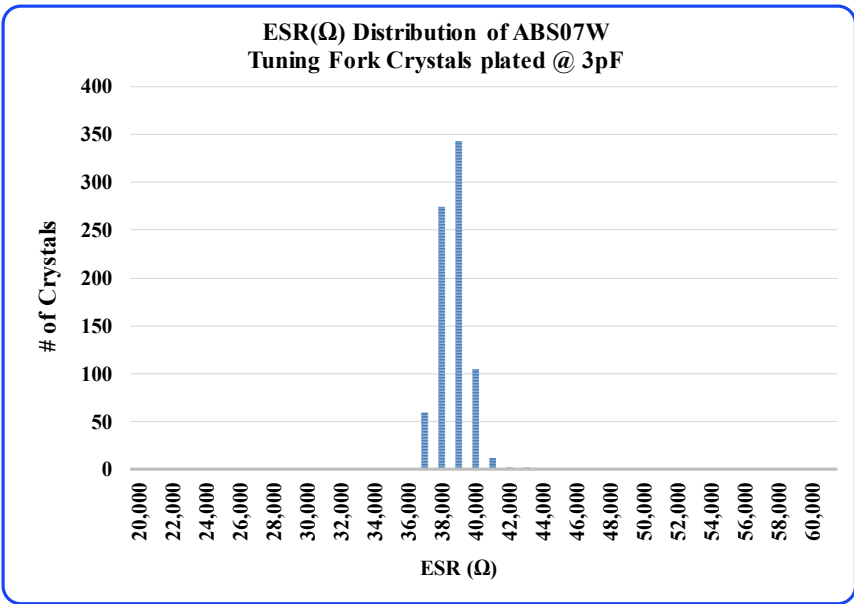
ABS07W - 32.768kHz - - -

OPERATING TEMP RANGE	FREQ. TOLERANCE	PACKAGING
D: -40°C ~ +85°C	1: ±10 ppm	Blank: Bulk
J: -40°C ~ +105°C	2: ±20 ppm	T: Tape & Reel
K: -40°C ~ +125°C		(3,000pcs/reel)

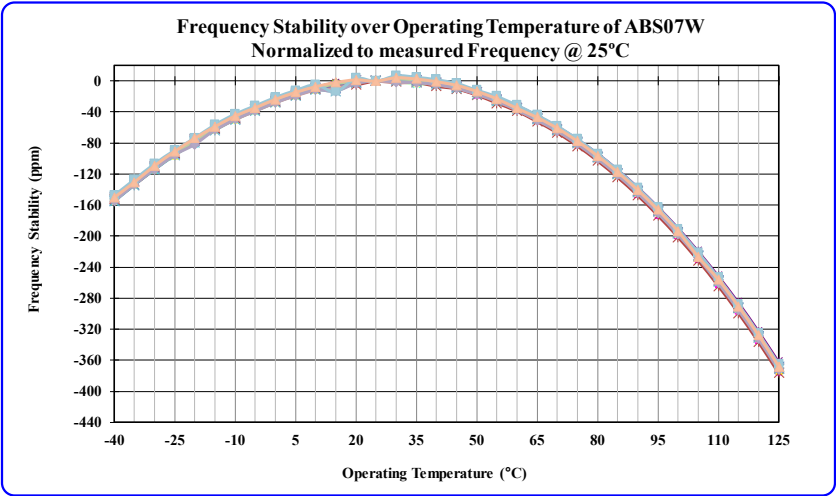
TYPICAL FREQUENCY TOLERANCE DISTRIBUTION (AT 25°C ± 3°C)



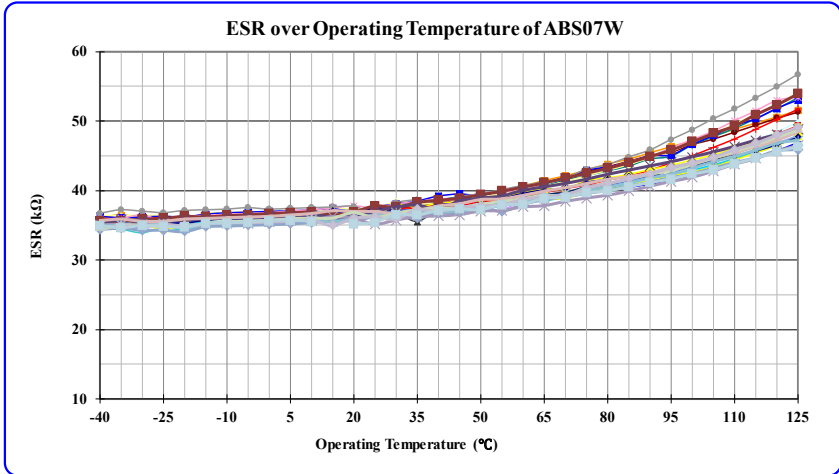
TYPICAL ESR DISTRIBUTION (AT 25°C ± 3°C)



TYPICAL FREQUENCY Vs. TEMPERATURE CHARACTERISTICS



TYPICAL ESR (EQUIVALENT SERIES RESISTANCE) Vs. OPERATING TEMPERATURE



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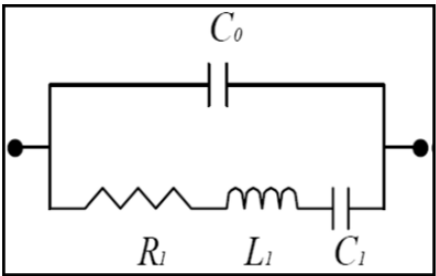


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SPICE MODEL (BASED ON TYPICAL VALUES AT 25°C ± 3°C):

Quartz Crystal Equivalent Circuit

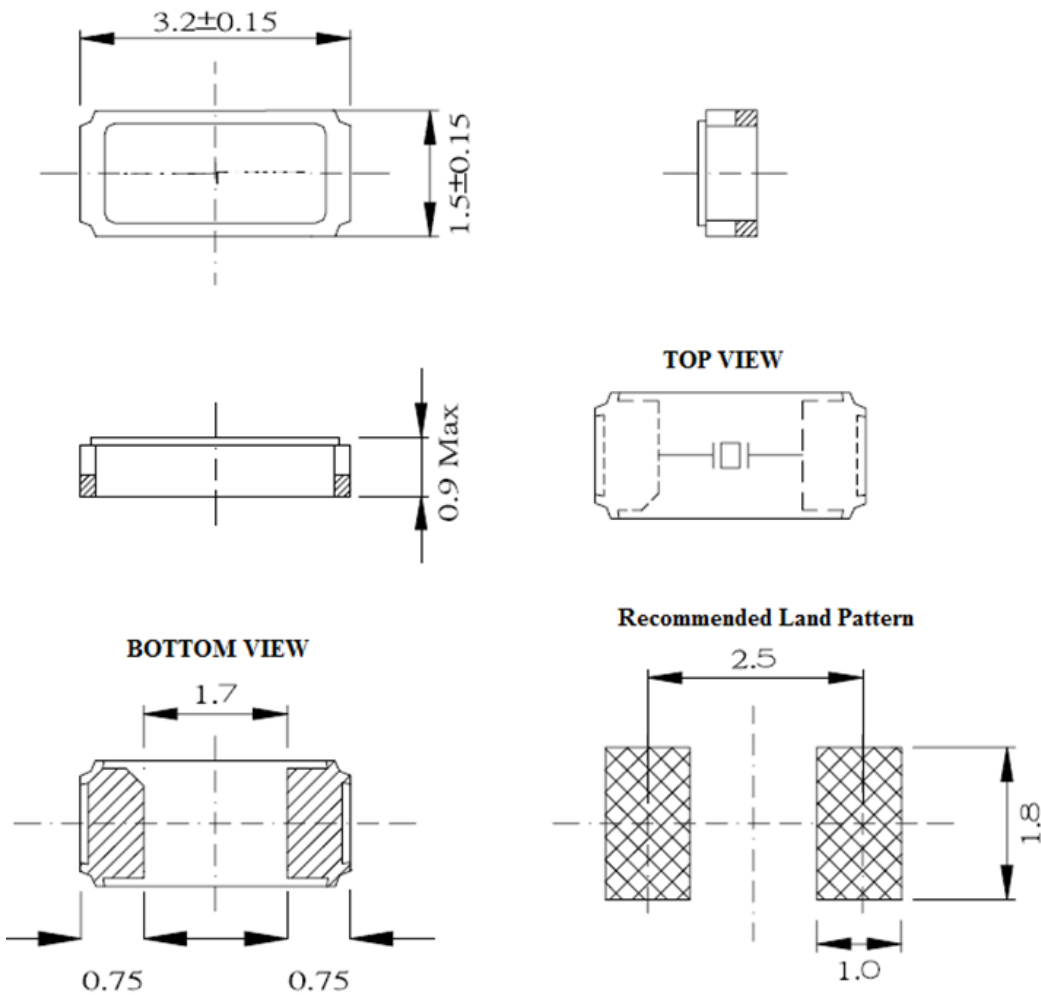


Frequency: 32.78kHz

Plating Load (CL) = 3pF

C0 = 1.15 pF
R1 = 38,194 Ω
L1 = 5,048,571 mH
C1 = 4.68 fF

MECHANICAL DIMENSIONS



DIMENSIONS: mm

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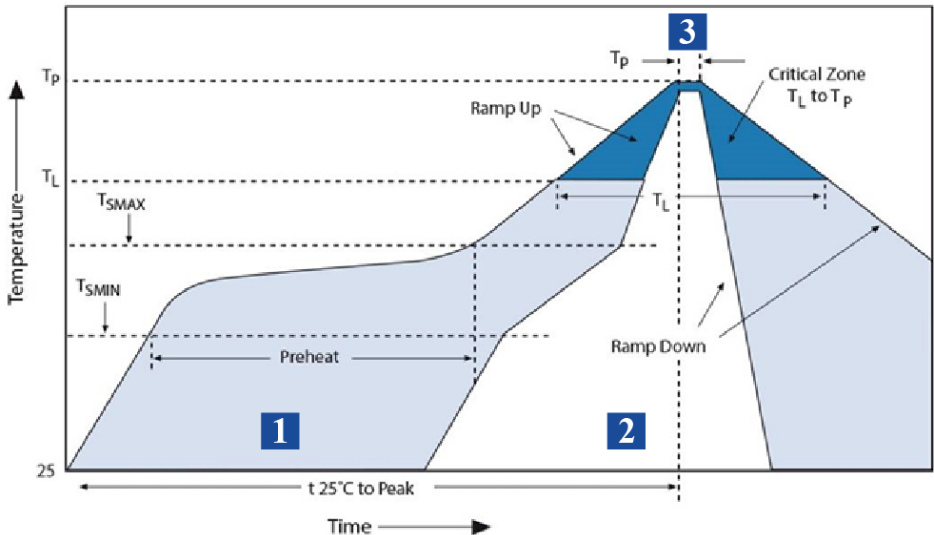


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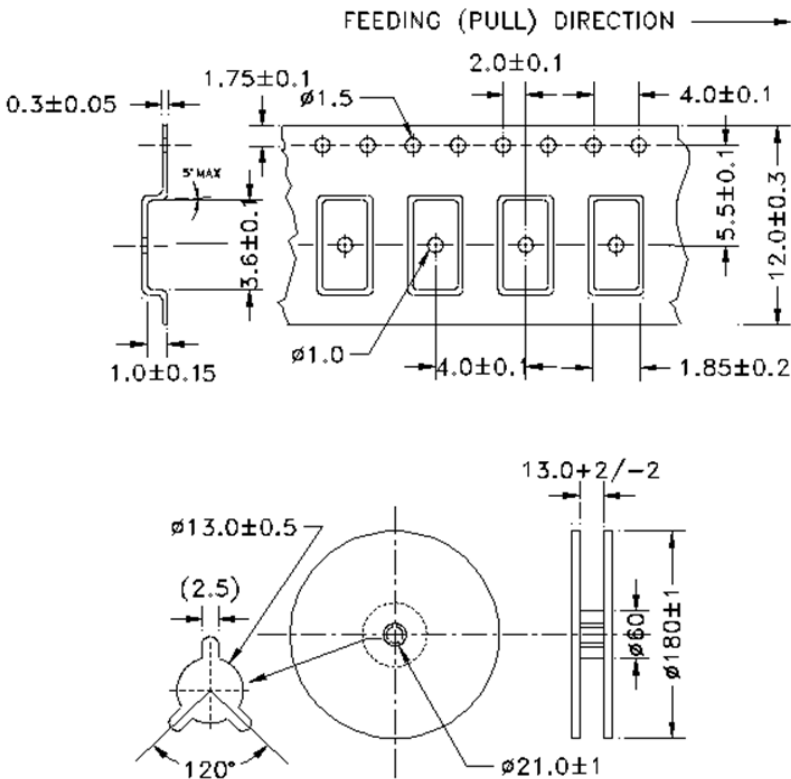
RECOMMENDED REFLOW PROFILE



Zone	Description	Temperature	Time
1	Preheat	$T_{S\text{MIN}} \sim T_{S\text{MAX}}$ 150°C ~ 200°C	60 ~ 120 sec.
2	Reflow	T_L 217°C	60 ~ 150 sec.
3	Peak Heat	T_p 260 ± 5°C	10 ± 5 sec. MAX

PACKAGING

TAPE AND REEL (3,000PCS/REEL)



DIMENSIONS: mm